



銀行授信申請書
APPLICATION FOR BANKING FACILITIES

致 To: 玉山商業銀行股份有限公司, 香港分行(「貴行」) E.SUN COMMERCIAL BANK, LTD., Hong Kong Branch (the "Bank")

申請人 Applicant		公司註冊證號碼 Certificate of Incorporation No./ 身份證號碼 ID No.		行業類別 Scope of Business	
代表人 Representative (公司適用 Corporate Only)		住宅地址 Residential Address/註冊辦事處 地址 Registered Office Address		電話號碼 Telephone Number	

申請種類 Facility Type	申請金額 Facility Limit	期間 Period	用途 Purposes (請填寫用途代號) (Fill in the Purpose Code)	動用方式 Methods of Drawdown(請填 寫動用代號)(Fill in the Drawdown Code)	償還方式 Methods of Repayment (請填寫償還代號)(Fill in the Repayment Code)
<input type="checkbox"/> 短期借款 Short-term Loan					

用途代號 The Purpose Code : 1.營運週轉 Working Capital 2.購置不動產 Purchase Real Estate 3.企業投資 Corporate Investment
4.避險理財 Hedge Financing 5.其他 Other _____

動用方式代號 The Drawdown Code : 1.一次 One Time 2.分次 Multiple Times 3.循環 Revolving

償還方式代號 The Repayment Code : 1.本息平均攤還 Equal Total Payment 2.按月繳息, 本金到期清償 Monthly Interest
Payment and Principal Payment on Maturity Date 3.依約屆期履行 Payment according to Contractual Obligations
4.其他 Others: _____

償還來源
The source of fund
for repayment

營業收入 Sales Revenue 盈餘 Earnings
 投資收入 Investment Revenue 其他 Other _____

擔保品種類
Collateral type

存款 Deposit 不動產 Property 其他 Others: _____

連帶保證人 JOINT AND SEVERAL GUARANTOR(S)

英文姓名/名稱 (中文姓名/名稱) Name in English (Name in Chinese)	與申請人關係 Relationship with the Applicant	公司註冊號碼/身份 證號碼 / 護照號碼 Company Number/ ID No./ Passport No.	電話號碼 Telephone Number	地址/註冊辦事處地址 Address/ Registered Office Address

DECLARATION BY APPLICANT/ JOINT AND SEVERAL GUARANTOR(S)

(Applicable to Companies only) We declare that we have authorized the signatory(ies) on our behalf to sign this Application Form and any other documents and to do such acts and things as may be necessary for the purpose of this application.

I/We hereby declare that all the information given in this Application Form is correct, update, complete and true. I/We undertake to notify the Bank in writing immediately of any subsequent change of facts or circumstances which may render any information, statements, representations and/or particulars given hereunder, incomplete, incorrect or untrue provided by us.

I/We confirm and acknowledge that the Bank will rely on the above information (including but not limited to the debts information and usage of collateral) to approve this application for banking facility. I/We fully understand that by making any intentional or negligent misrepresentation(s) and/or providing false information and/or omitting to provide any relevant information in this Application Form, I/we (including the shareholders, directors and/or authorized representatives of the Company) may incur civil and/or criminal liabilities, including but not limited to committing the offence of fraud if I/we make a false declaration to obtain a banking facility.

I/We understand that the Bank will not be able to provide any banking facility and services to me/us if I/we fail to provide the above information or any other relevant information requested by the Bank or if the provided information is found to be incorrect, incomplete and untrue. I/We acknowledge that the Bank reserves the final discretion for the approval of this banking facility application.

(Applicable to Individuals only) I/We authorize the Bank to contact any of my/our employers (if applicable), financial institutions or any other source of information for the verification of the above information provided and for the collection of such information as used for the processing and evaluation of this application for banking facility.

(Applicable to Companies only) We agree that we are not insolvent or not in winding up or no similar proceeding has ever been commenced/considered or is currently pending against us. We confirm that the shareholder(s) of us has/have not resolved or intend to resolve for dissolution/merger or acquisition.

(Applicable to Individuals only) I/We confirm that I/we did not own any loan/ credit card that was cancelled due to default payment and currently I/we do not have any overdue payment exceeding 30 days in respect of any indebtedness with any financial institution. I/We further confirm that (i) I/we are not bankrupt or intend to apply for bankruptcy petition or in similar proceedings; (ii) no petition for bankruptcy is presented against me/us; and (iii) there is no application by us or any other person for an interim order for making a debt proposal for voluntary arrangements.

I/We acknowledge that I/we have been provided with a copy of the Bank's Notice to Customers relating to the Personal Data (Privacy) Ordinance, the Privacy Policy and Disclaimer and the Mandatory Disclosure Regarding Use of Personal Data by E.SUN Bank ("PDPO Notice") and consent to the Bank for its use and disclosure of personal data in the manner as stipulated therein. I/We have read and understood that the PDPO Notice records your Bank's policies and practices from time to time in force relating to my/our personal data and information provided above for the purposes set out in the PDPO Notice in any country.

(Applicable to Individuals only) I/We further confirm and agree that the Bank may conduct the verification procedure defined in the Personal Data (Privacy) Ordinance, provide the bank certificate relating to me/us and provide all personal data of me/us to credit information institutions, and provide them to debt collection companies in case of arrears.

I/We agree that the Bank may appoint debt collection agencies to recover any overdue amount against the mortgagor(s), borrower(s), joint and several guarantor(s) and/or third party security provider(s) and requires the mortgagor(s), the borrower(s), the joint and several guarantor(s) and/or third party security provider(s) to indemnify the Bank for all reasonable costs and expenses to be incurred in the debt recovery process.

I/We agree that the Bank may enquire/disclose our information to all parties (including but not limited to Taiwan Joint Credit Information Center and Small and Medium Enterprise Credit Guarantee Fund of Taiwan) related to this application.

The above declaration shall be governed by and construed in accordance with the laws of Hong Kong Special Administrative Region ("Hong Kong") and each party agrees to submit to the non-exclusive jurisdiction of the Hong Kong Courts.

Signature(s) of the Authorized Signatory(ies) of the Applicant with Company Chop

Signature(s) of the joint and several Guarantor(s)

Please write down the full name(s) of the Authorized Signatory(ies) under the signature(s).

Date:

Please write down the full name(s) under the signature(s).

Date: